

FIG. 1

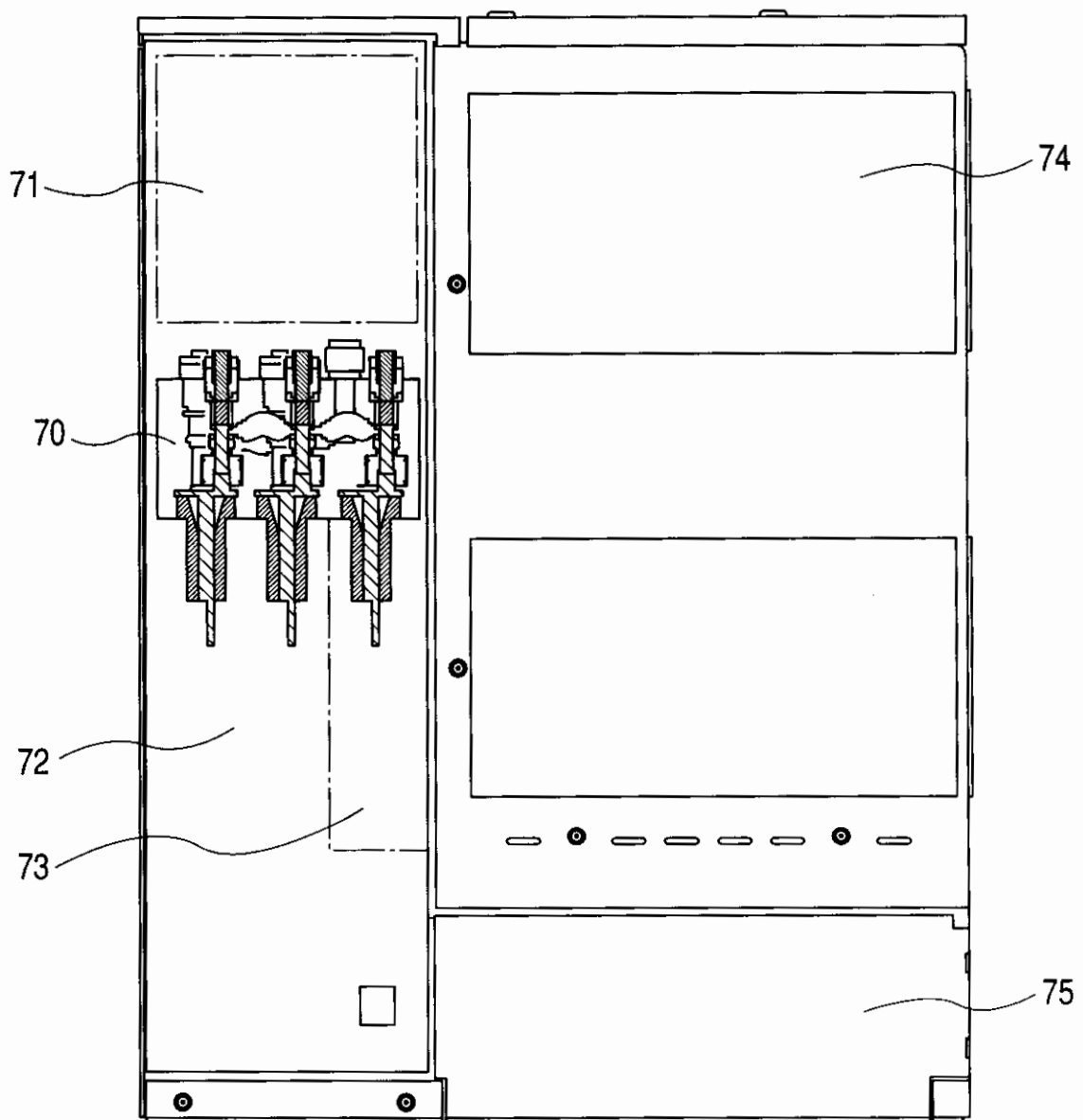


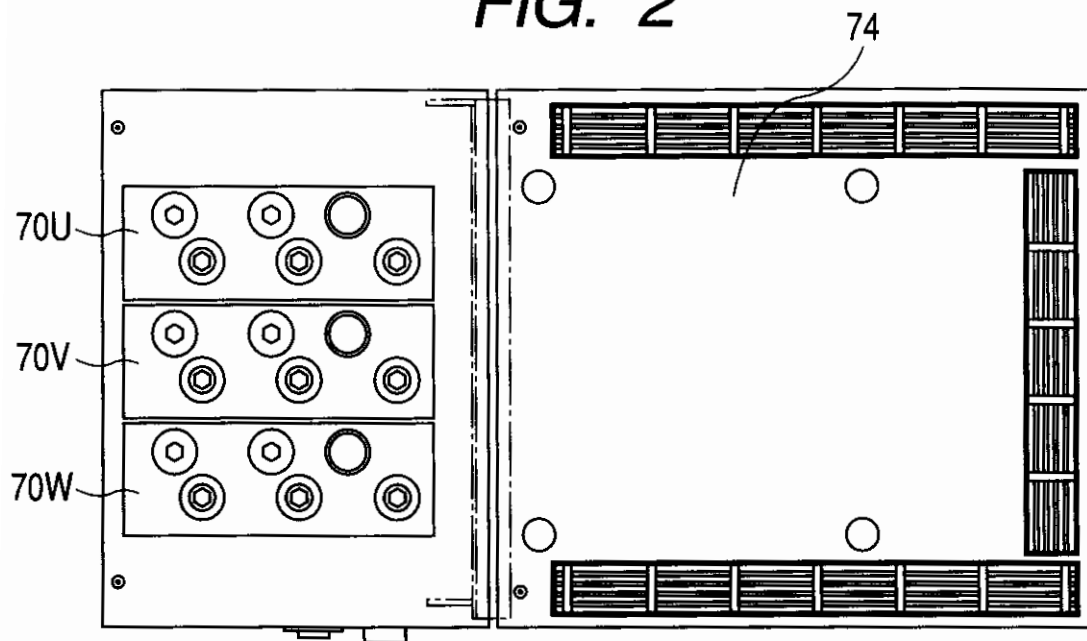
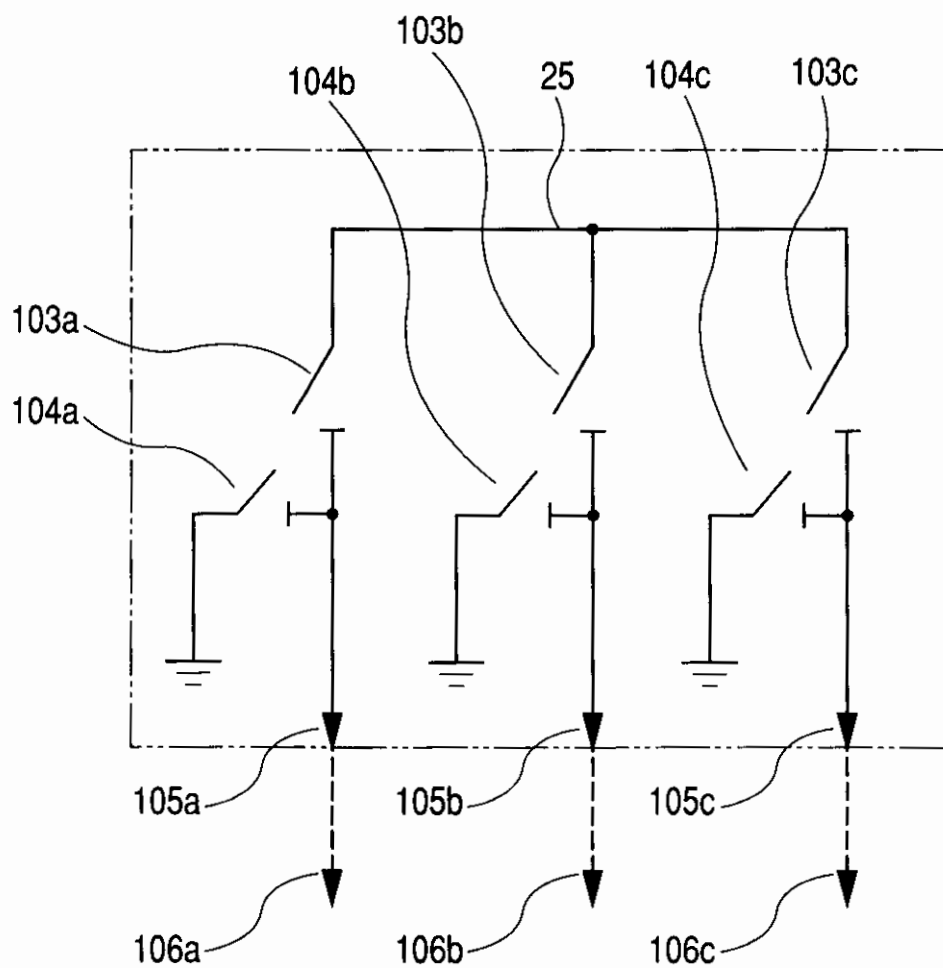
FIG. 2**FIG. 3**

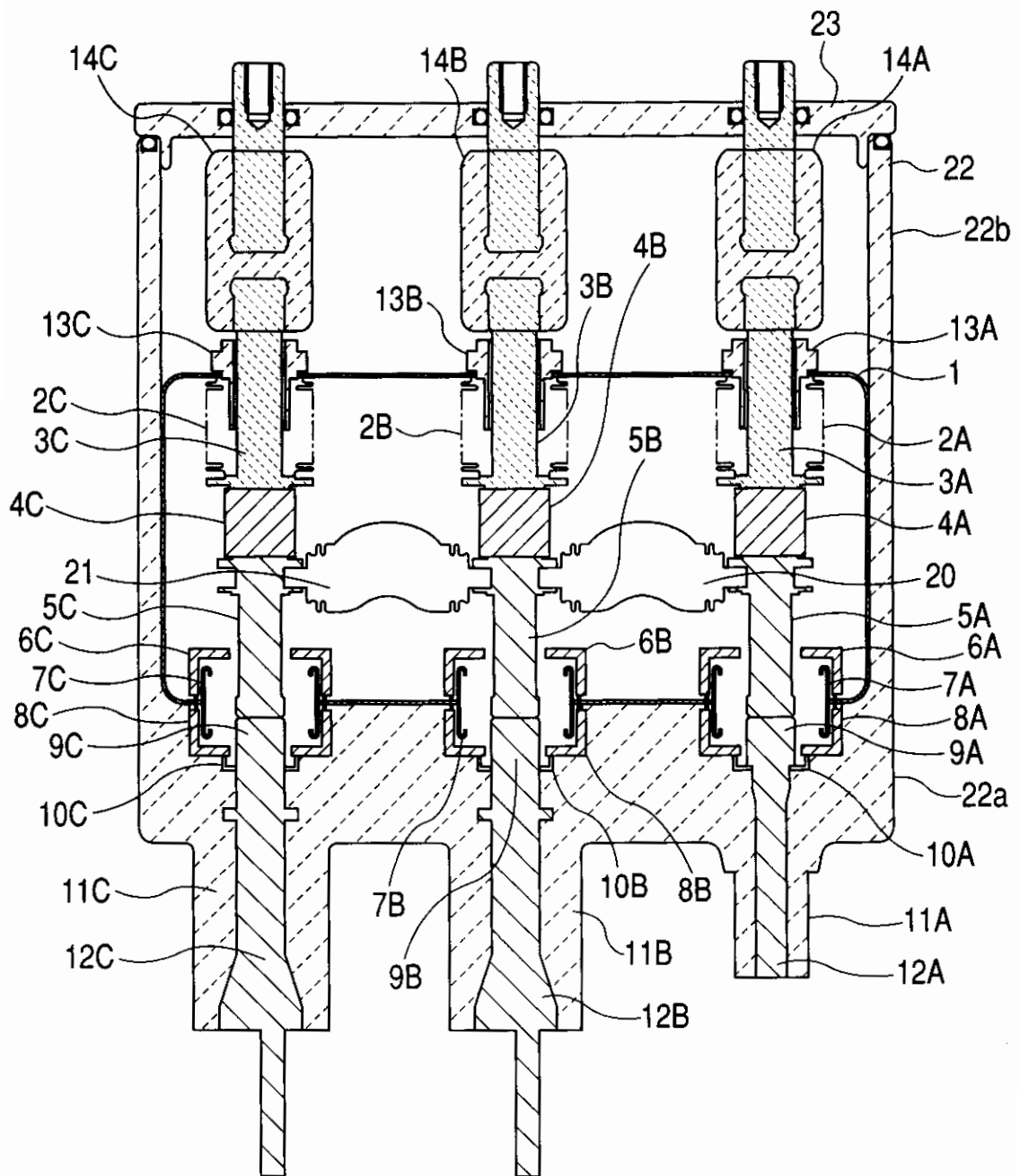
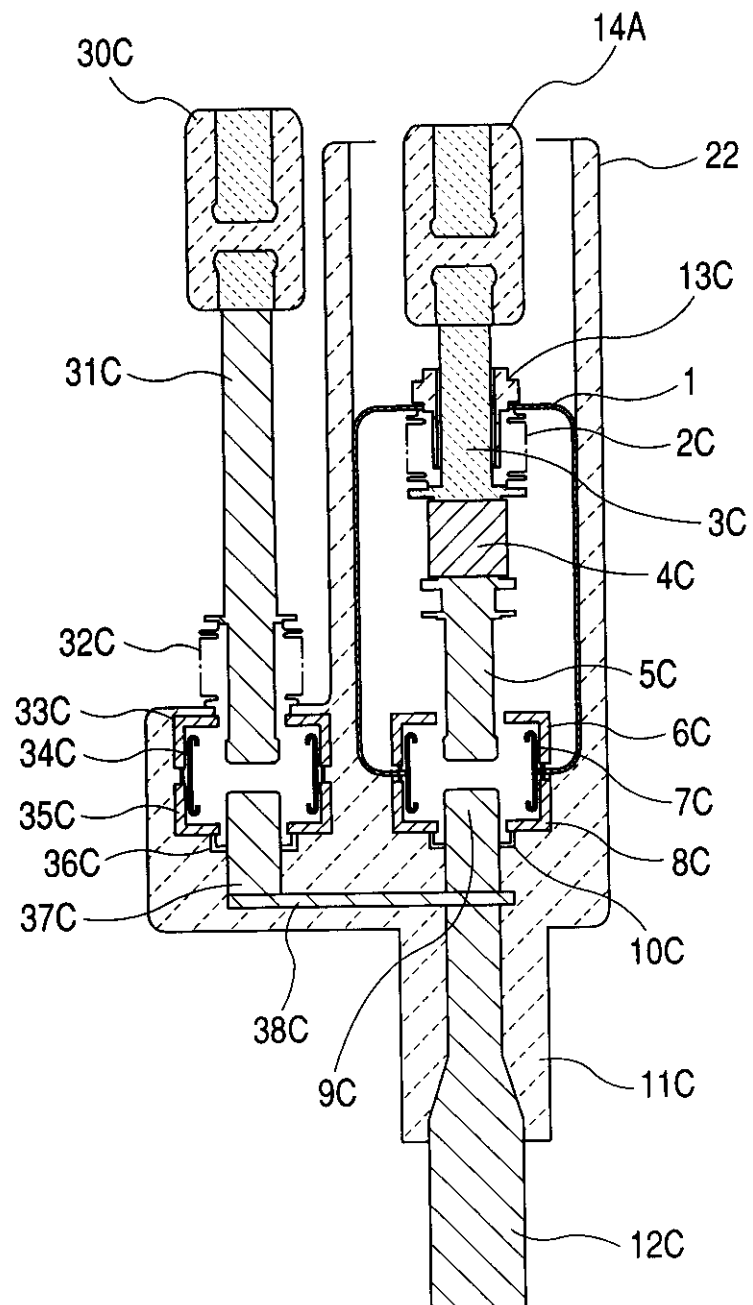
FIG. 4

FIG. 5

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FIG. 6

FIG. 6 is a cross-sectional view of a multi-layered electronic assembly. The assembly consists of a top layer (1) with a central region (2) and side regions (3, 4). Below this is a middle layer (5) with a central region (6) and side regions (7, 8, 9, 10). The bottom layer (11) has a central region (12) and side regions (13, 14). Various components are labeled with numbers 1 through 14, with subscripts A, B, and C indicating different parts or layers. The assembly is shown in a cross-section, revealing the internal structure and the arrangement of the layers.

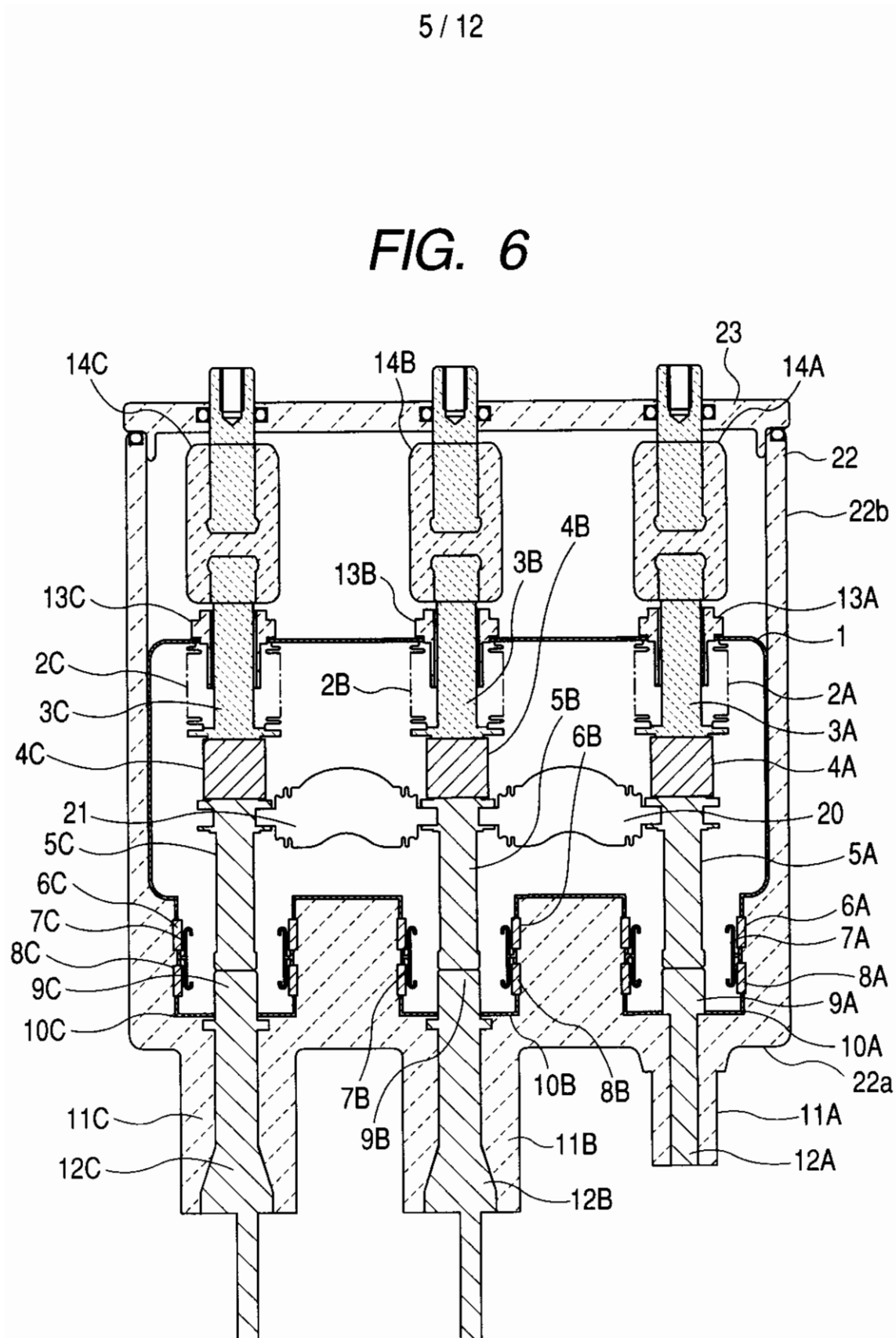


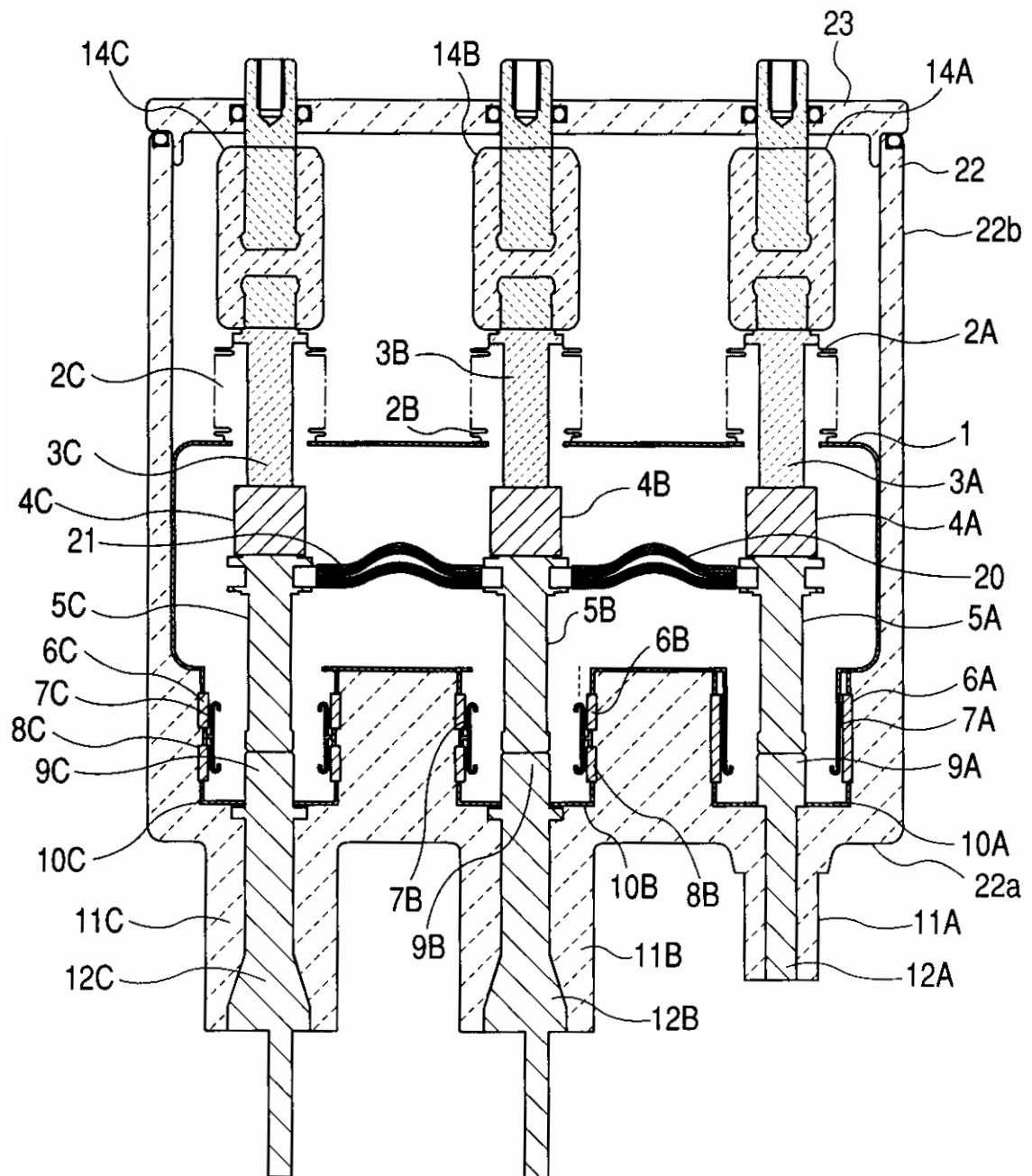
FIG. 7

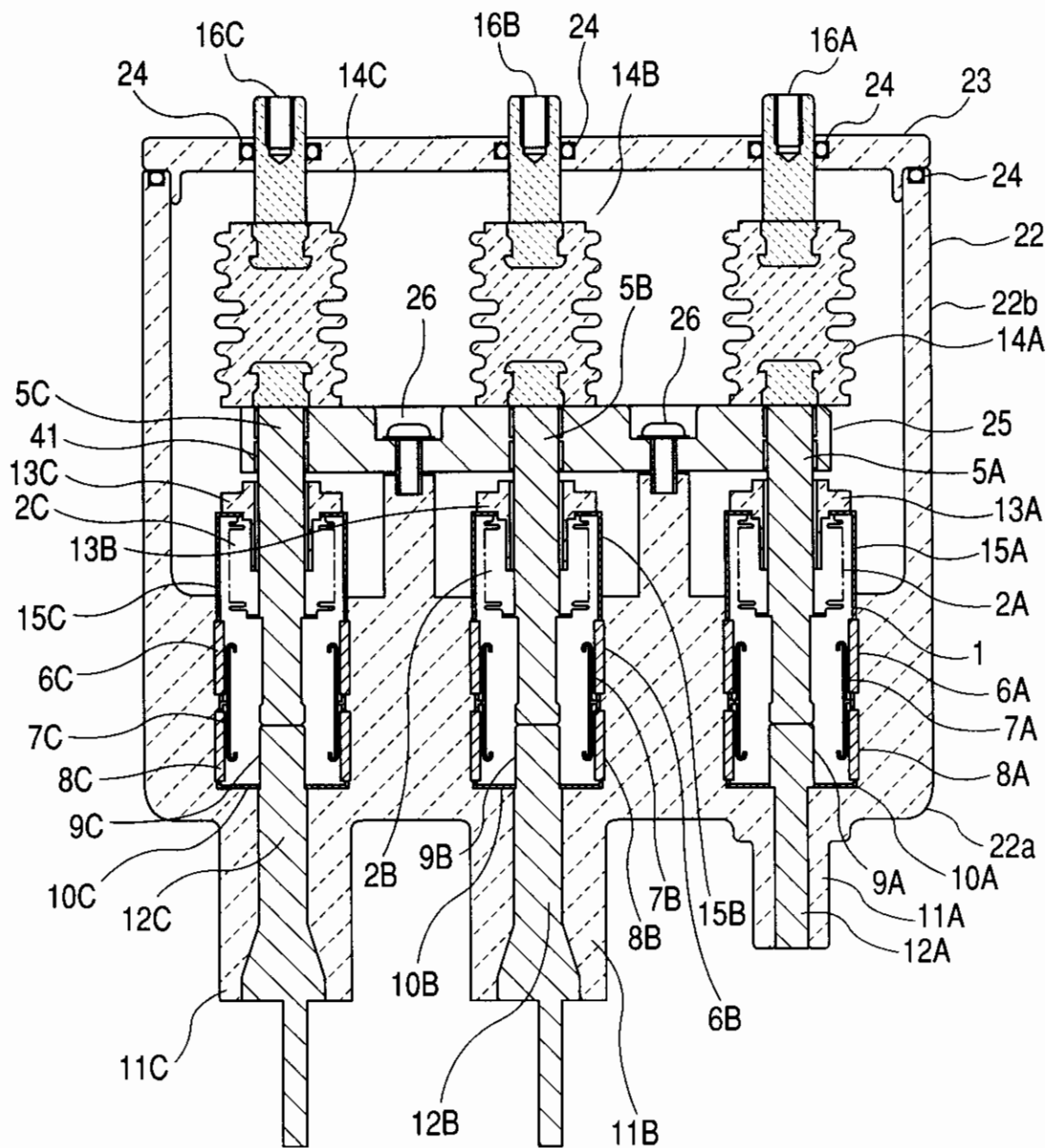
FIG. 8

FIG. 9

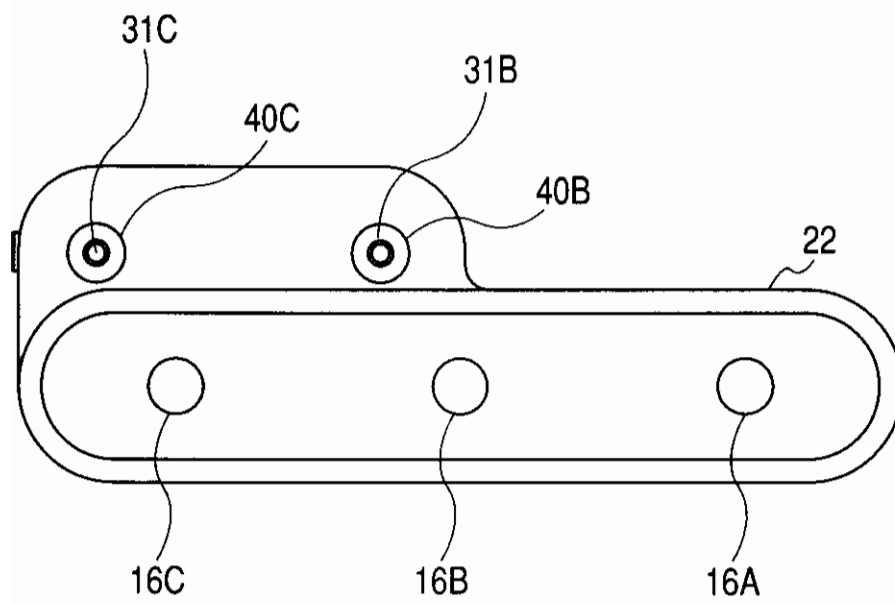


FIG. 10

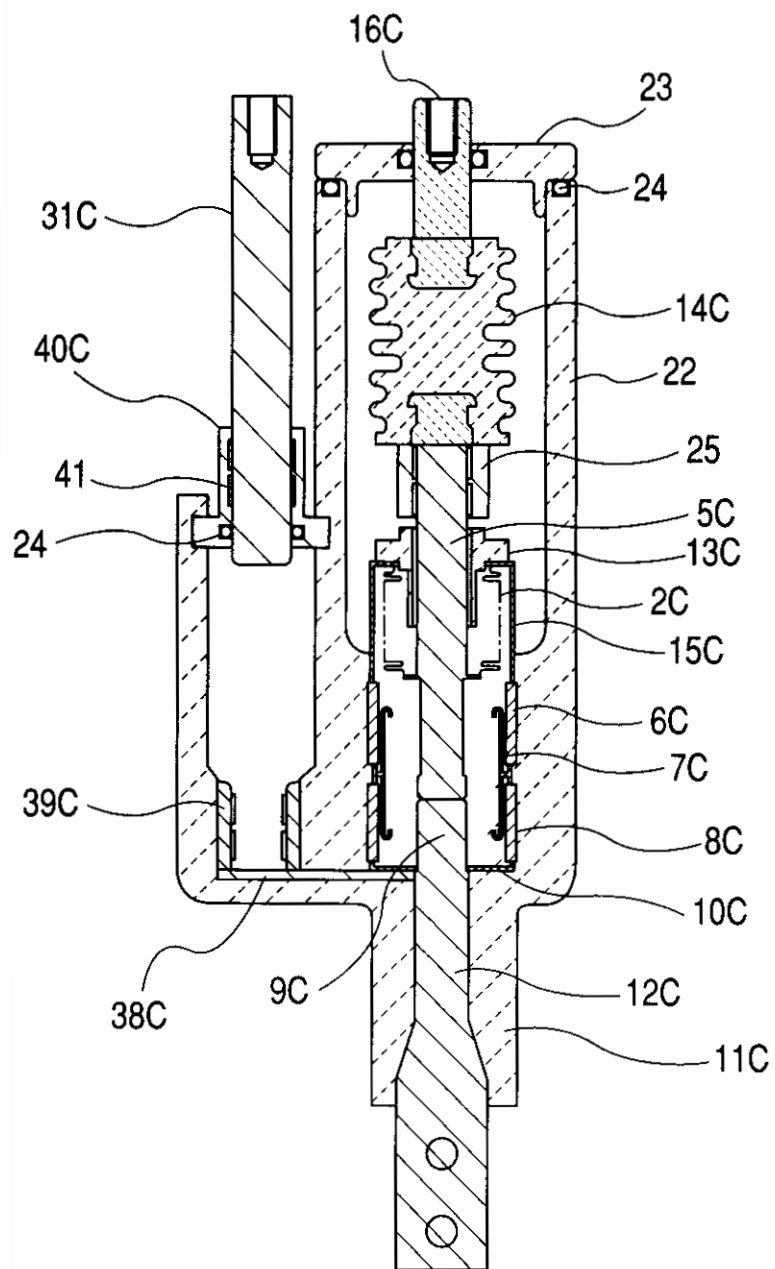


FIG. 11

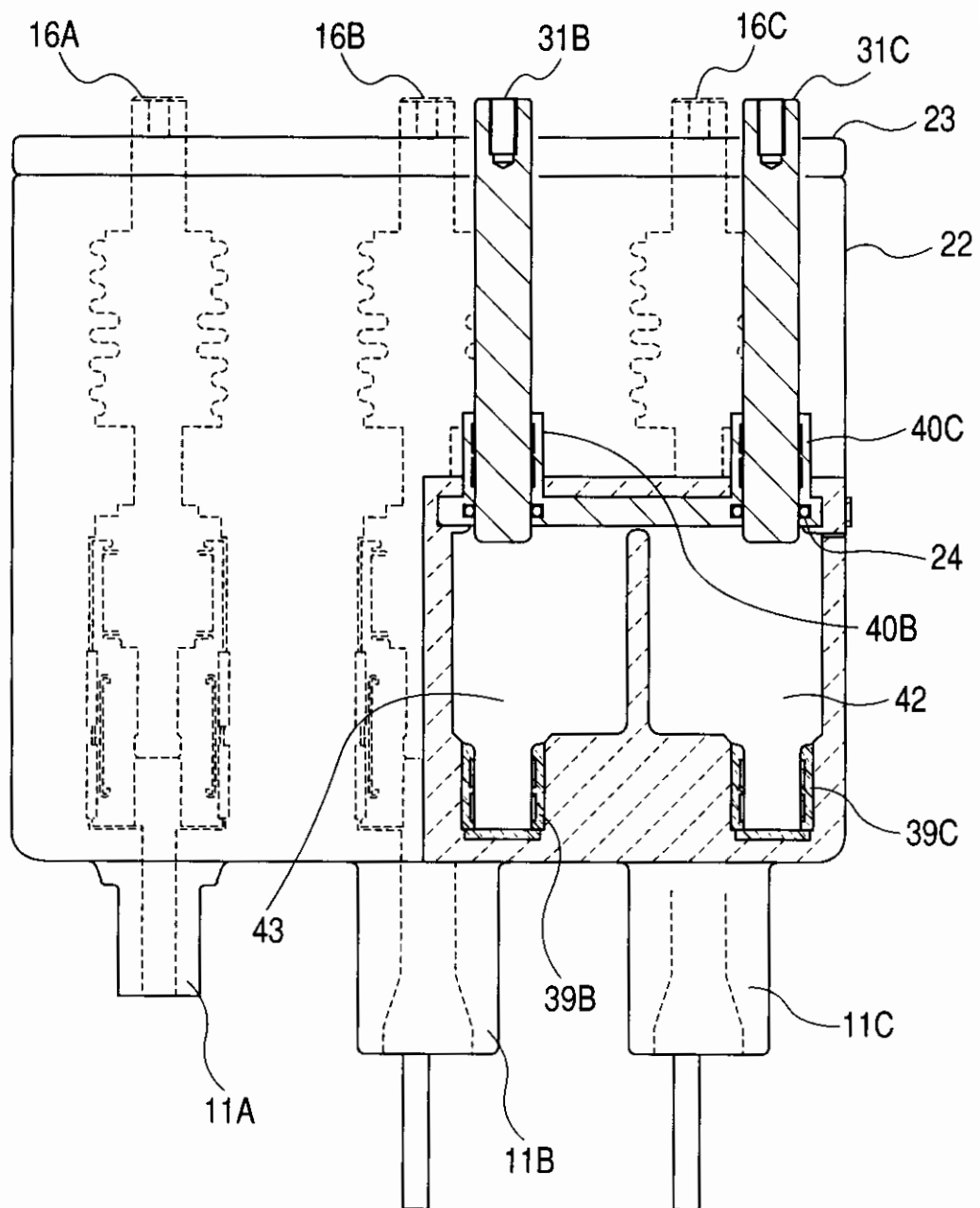


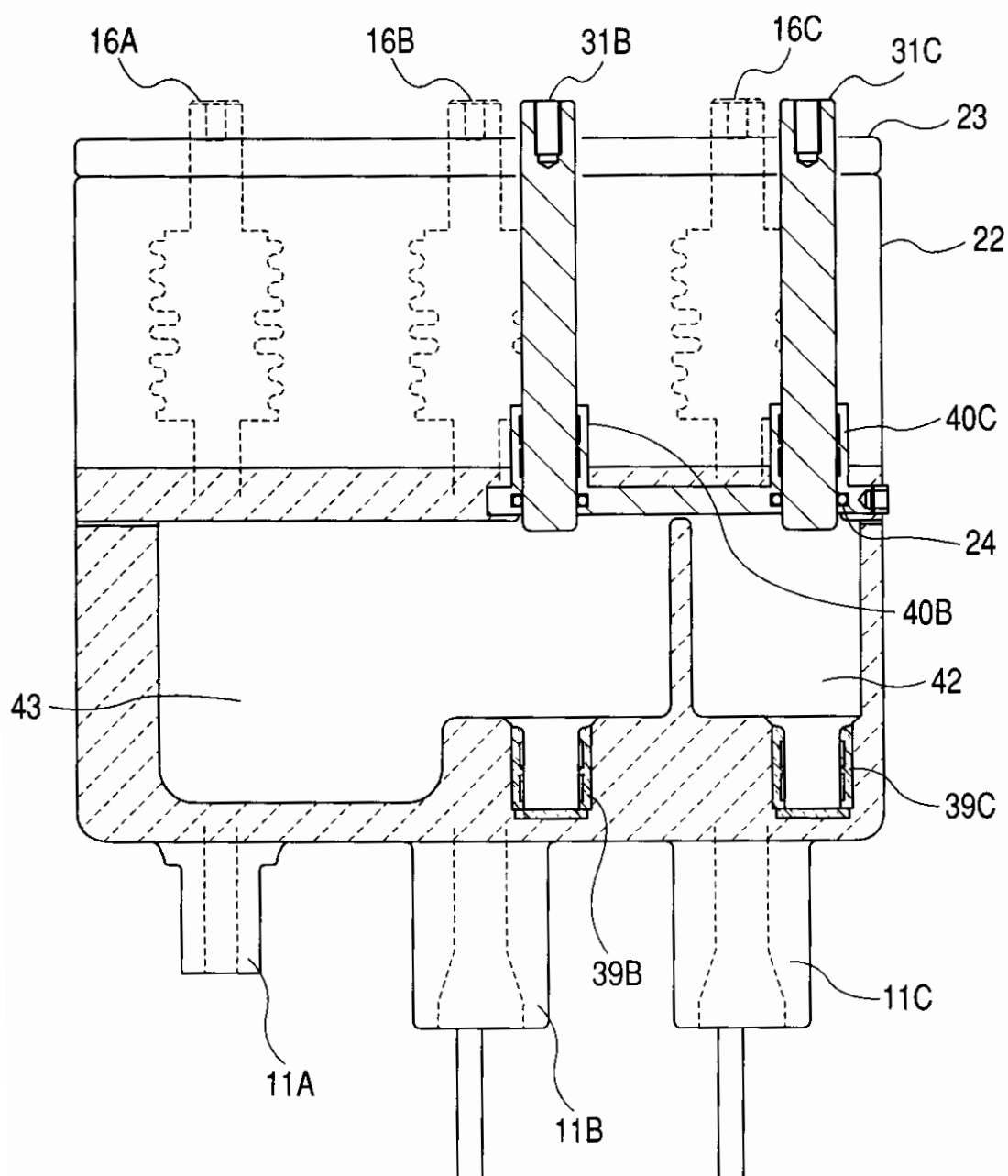
FIG. 12

FIG. 13